

MOS FIELD EFFECT TRANSISTOR 2SK2363/2SK2364

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK2363/2SK2364 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

FEATURES

• Low On-Resistance

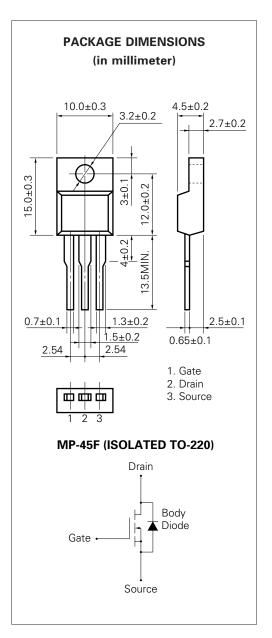
2SK2363: RDS (on) = 0.5 Ω (VGS = 10 V, ID = 4.0 A) 2SK2364: RDS (on) = 0.6 Ω (VGS = 10 V, ID = 4.0 A)

- Low Ciss Ciss = 1600 pF TYP.
- · High Avalanche Capability Ratings
- Isolate TO-220 Package

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage (2SK2363/2SK2364)	VDSS	450/500	V
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	I _{D(DC)}	±8.0	Α
Drain Current (pulse)*	ID(pulse)	±32	Α
Total Power Dissipation ($T_c = 25$ °C)	P _{T1}	35	W
Total Power Dissipation (T _A = 25 °C)	P _{T2}	2.0	W
Channel Temperature	T_ch	150	°C
Storage Temperature	T _{stg} -	-55 to +150	°C
Single Avalanche Current**	las	8.0	Α
Single Avalanche Energy**	Eas	320	mJ

- * PW \leq 10 μ s, Duty Cycle \leq 1 %
- ** Starting Tch = 25 °C, Rg = 25 Ω , Vgs = 20 V \rightarrow 0



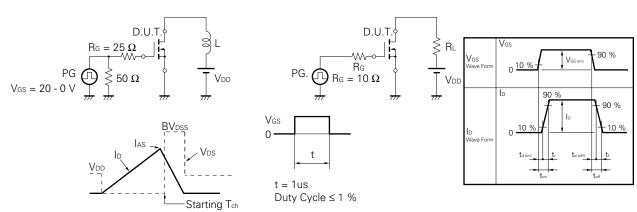


ELECTRICAL CHARACTERISTICS (TA = 25 °C)

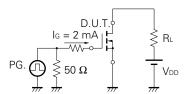
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS	
Drain to Source On-Resistance	RDS (on)		0.4	0.5	Ω	Vgs = 10 V	2SK2363
			0.5	0.6	Ω	ID = 4.0 A	2SK2364
Gate to Source Cutoff Voltage	VGS (off)	2.5		3.5	V	V _{DS} = 10 V, I _D = 1 mA	
Forward Transfer Admittance	yfs	4.0			S	VDS = 10 V, ID = 4.0 A	
Drain Leakage Current	IDSS			100	μΑ	V _{DS} = V _{DSS} , V _{GS} = 0	
Gate to Source Leakage Current	Igss			±100	nA	V _G S = ±30 V, V _D S = 0	
Input Capacitance	Ciss		1600		pF	V _{DS} = 10 V	
Output Capacitance	Coss		310		pF	Vgs = 0	
Reverse Transfer Capacitance	Crss		30		pF	f = 1 MHz	
Turn-On Delay Time	td (on)		20		ns	ID = 4.0 A	
Rise Time	tr		13		ns	Vgs = 10 V	
Turn-Off Delay Time	td (off)		83		ns	V _{DD} = 150 V	
Fall Time	tf		16		ns	$R_G = 10 \Omega R_L = 37.5 \Omega$	
Total Gate Charge	QG		42		nC	ID = 8 A	
Gate to Source Charge	Qgs		10		nC	V _{DD} = 400 V	
Gate to Drain Charge	QgD		20		nC	V _G S = 10 V	
Body Diode Forward Voltage	VF (S-D)		1.0		V	IF = 8 A, VGS = 0	
Reverse Recovery Time	trr		350		ns	IF = 8 A, VGS	= 0
Reverse Recovery Charge	Qrr		1.5		μC	di/dt = 50 A/	μs

Test Circuit 1 Avalanche Capability

Test Circuit 2 Switching Time

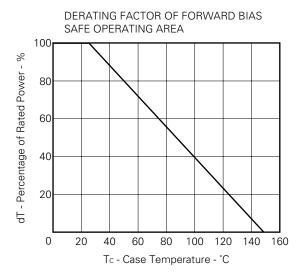


Test Circuit 3 Gate Charge

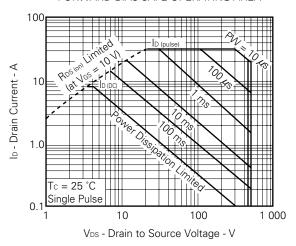


The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

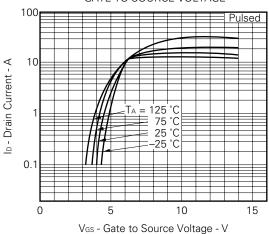
TYPICAL CHARACTERISTICS (TA = 25 °C)

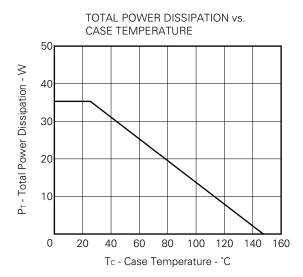


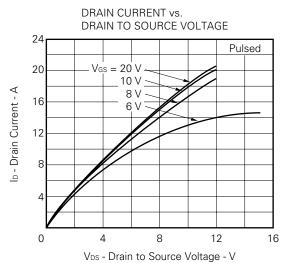
FORWARD BIAS SAFE OPERATING AREA

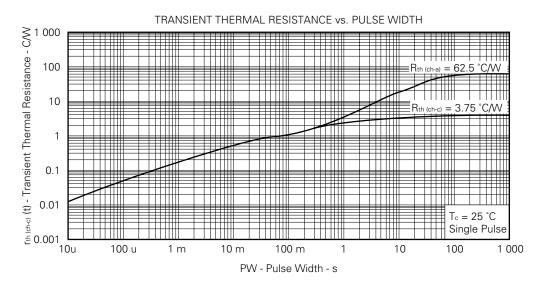


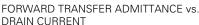
DRAIN CURRENT vs.
GATE TO SOURCE VOLTAGE

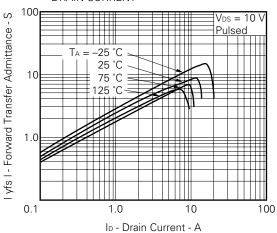




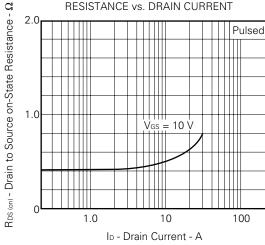




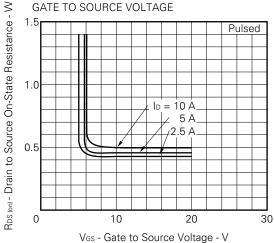




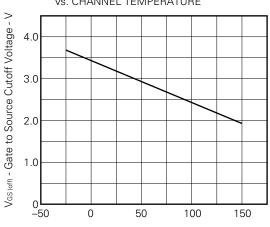
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

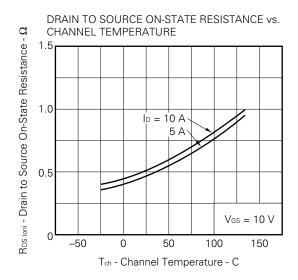


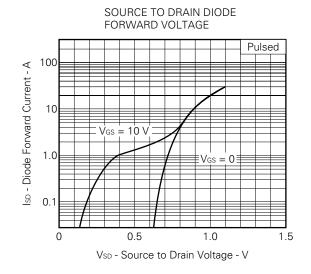
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

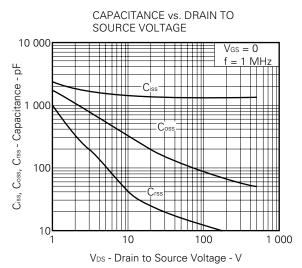


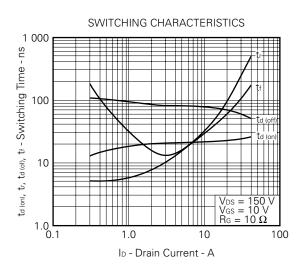
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

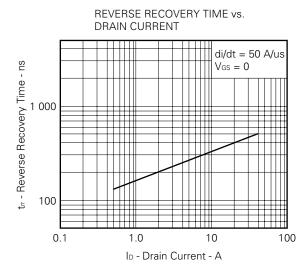


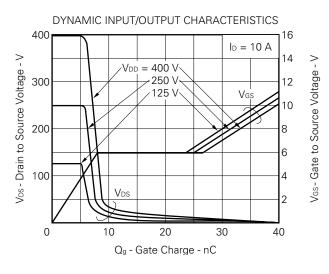






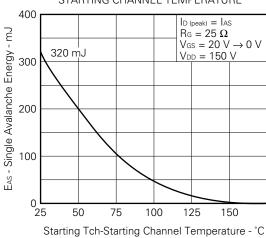




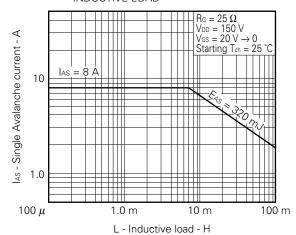




SINGLE AVALANCHE ENERGY vs. STARTING CHANNEL TEMPERATURE



SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD



REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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Anti-radioactive design is not implemented in this product.